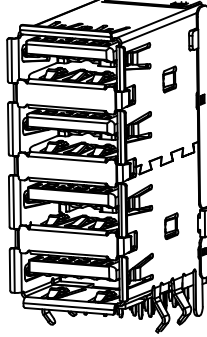
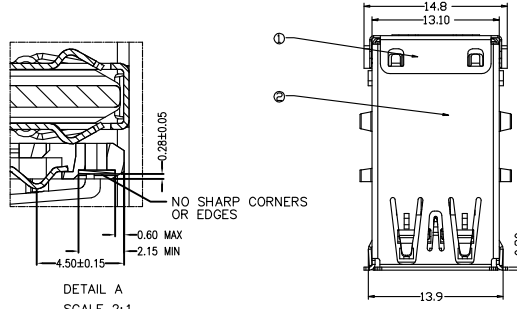


The product using material and processing must conform to the "WI-PZ-001"HSF technical standard control requirements

RoHS+HF



Gen 1

Gen 2

NOTES:

1. ELECTRICAL CHARACTERISTICS :

1-1. CONTACT CURRENT RATING:

1.5 A FOR VBUS PIN AND ITS CORRESPONDING GND PIN.
0.25 A MIN FOR ALL OTHER CONTACTS.

1-2. CONTACT RESISTANCE:

INITIAL 30 MILLIOHMS MAX FOR VBUS AND GND CONTACTS.
INITIAL 50 MILLIOHMS MAX FOR ALL OTHER CONTACTS.
AFTER DURABILITY 10 MILLIOHMS MAX CHANGE.

1-3. DIELECTRIC WITHSTANDING VOLTAGE : 100 VRMS AC MIN.

1-4. INSULATION RESISTANCE:100 MEGOHMS MIN.

2. MECHANICAL CHARACTERISTICS:

2-1. CONNECTOR MATING FORCE: 35N MAX.

2-2. CONNECTOR UNMATING FORCE: 10N~35N INITIAL, 8N~35N AFTER DURABILITY.

2-3. DURABILITY: 5000 CYCLES.

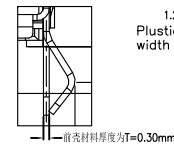
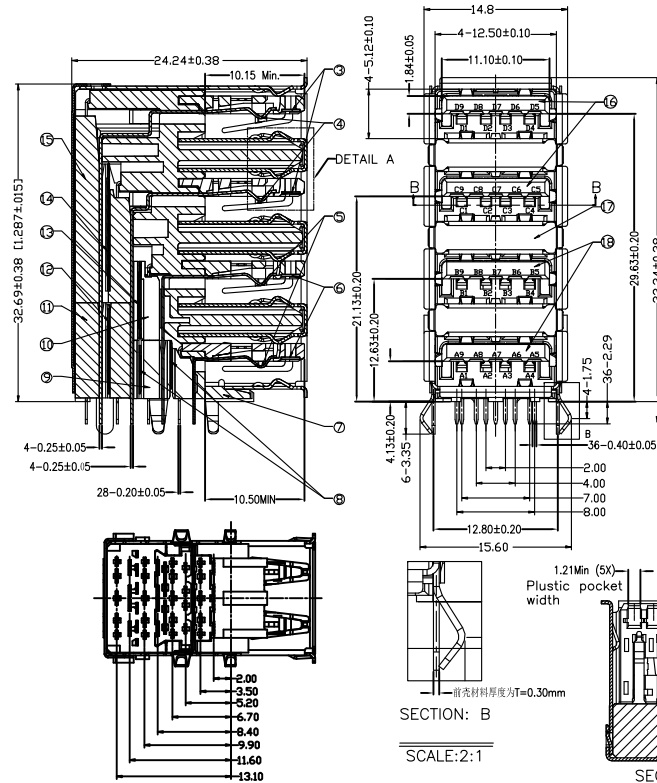
2-4. OPERATING TEMPERATURE: -40°C~+85°C

3. PACKAGE SPEC: TRAY

PIN ASSIGNMENT:

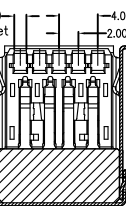
Pin No.	D1	D2	D3	D4	D5	D6	D7	D8	D9
Pin No.	C1	C2	C3	C4	C5	C6	C7	C8	C9
Pin No.	B1	B2	B3	B4	B5	B6	B7	B8	B9
Pin No.	A1	A2	A3	A4	A5	A6	A7	A8	A9
Signal Name	VBUS	D-	D+	GND	STDA_SSRX-	STDA_SSRX+	GND_DRAIN	STDA_SSTX-	STDA_SSTX+
Remark	USB2.0 Contact Pin				USB3.0/3.1 Contact Pin				

18	3.1 INSERT MOLDING	2	PA66, UL 94V-0	MOLDED COLOR:BLACK / Halogen Free
17	FINGER	3	SUS304 3/4H(T=0.30±0.01mm)	CLEAN
16	3.0 INSERT MOLDING	2	PA66, UL 94V-0	MOLDED COLOR:BLACK / Halogen Free
15	UPPER SPACER	1	PA66, UL 94V-0	MOLDED COLOR:BLACK / Halogen Free
14	GROUND SHIELDING 4	1	SUS304 3/4H(T=0.15±0.01mm)	CLEAN
13	GROUND SHIELDING 2	1	SUS304 3/4H(T=0.15±0.01mm)	CLEAN
12	GROUND SHIELDING 3	1	SUS304 3/4H(T=0.15±0.01mm)	CLEAN
11	LOWER SPACER	1	PA66, UL 94V-0	MOLDED COLOR:BLACK / Halogen Free
10	FRONT SPACER 2	1	PA66, UL 94V-0	MOLDED COLOR:BLACK / Halogen Free
9	FRONT SPACER 1	1	PA66, UL 94V-0	MOLDED COLOR:BLACK / Halogen Free
8	GROUND SHIELDING 1	2	SUS304 3/4H(T=0.15±0.01mm)	CLEAN
7	HOUSING	1	PA66, UL 94V-0	MOLDED COLOR:BLACK / Halogen Free
6	USB3.1 CONTACT	10	C2680R-SH(T=0.20±0.01mm)	1u" Min G/F AND 30u" Pd/Ni MIN AT CONTACT A
5	USB2.0 CONTACT	8	C2680R-SH(T=0.20±0.01mm)	100u" Min LEAD FREE TIN ALLOY AT TERMINATION,
4	USB2.0 CONTACT	8	C7025 TM02(T=0.25±0.01mm)	50u" Min NICKEL UNDERPLATING OVER ALL.
3	USB3.0 CONTACT	10	C2680R-SH(T=0.20±0.01mm)	
2	FRONT SHELL	1	SUS304 3/4H(T=0.30±0.01mm)	10u" MIN. NI PLATED OVER ALL, 50~200u" TIN
1	REAR SHELL	1	SUS304 3/4H(T=0.20±0.01mm)	ALLOY (LEAD FREE) PLATED AT KINK AND TAB.
NO.	DESCRIPTION	QTY.	MATERIAL	TREATMENT



SECTION: B

SCALE:2:1



SEC: B-B

WLU3F9-36 1 X X 0048

PLATING: Colour:
1-G/F A:Black
2-AU 3U" K:White
5-AU 15U" G:Blue
6-AU 30U"

REV.	REVISION RECORD	DATE	GENERAL TOLERANCES	SCALE:	NAME	DATE	PART. NO:	DWG. NO:	WanLian Teconology Co., Ltd	
A0	NEW RELEASE	21.01.13	LINEAR	1:1	Wang_jr	21.01.13	WLU3F9-361XX0048	ENDE05		
			ANGLES	APPROVED	Ding_bo	21.01.13	TITLE:		REV: A0	SHEET: 1/2
			0.0±0.35	X° REF±6°	DESIGNER	Ou_jian	21.01.13	USB3.0 AF 四层 插板 打K脚		
			0.00±0.25	X° ±3°	DRAWN					
			0.000±0.10	X° X'±2°						

